



# DIN Signal male connector - SMC - tape & reel



## General information

Design	IEC 60603-2	types: 3B, 2C, 3Q, 3R male
No. of contacts	max. 48	
Contact spacing	2,54mm	
Test voltage	1000V	
Contact resistance	max. 15mOhm	
Insulation resistance	min. 10 <sup>10</sup> Ohm	
Working current	2A at 20°C (see derating diagram)	
Temperature range	-55°C ... +125°C	
Termination technology	SMC with solder pins	
Clearance & creepage distance	min. 1,2mm each	
Insertion and withdrawal force	20-pole max. 20N	
	30-pole max. 30N	
	48-pole max. 45N	
Mating cycles	PL 1 acc. to IEC 60603-2	500 mating cycles
	PL 2 acc. to IEC 60603-2	400 mating cycles
	PL 3 acc. to IEC 60603-2	50 mating cycles
UL file	E102079	
RoHS - compliant	Yes	
Leadfree	Yes	
Hot plugging	No	

## Insulator material

Material	PCT (thermoplastics, glass fiber reinforcement 30%)
Colour	natural coloured, colour deviations and speckles permitted
UL classification	UL 94-V0
Material group acc. IEC 60664-1	II (400 ≤ CTI < 600)
NFF classification	I3, F3

## Contact material

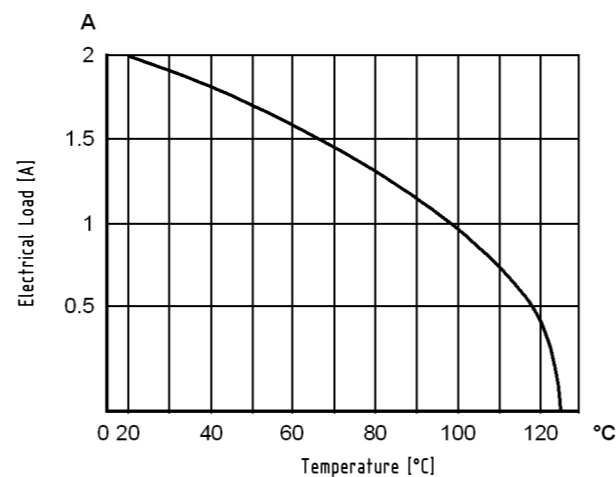
Contact material	Copper alloy
Plating termination zone	Sn over Ni
Plating contact zone	Au over PdNi over Ni

## Derating diagram acc. to IEC 60512-5 (current carrying capacity)

The current carrying capacity is limited by maximum temperature of materials for inserts and contacts including terminals.

The current capacity curve is valid for continuous, non interrupted current loaded contacts of connectors when simultaneous power on all contacts is given, without exceeding the maximum temperature.

Control and test procedures according to DIN IEC 60512-5



## Soldering instructions

SMC (Surface Mount Compatible) connectors are designed to be used in a reflow oven together with other SMD (Surface Mount Device) components. In this process, called as well „Pin in Hole Intrusive Reflow“, the connectors are inserted into plated through holes in a comparable way to conventional component mounting. All other components can be assembled on the pcb surface.

The length of the connector contacts should be such that they protrude by no more than 1.5 millimetres after insertion to the pcb. Each contact collects solder on its tip as it penetrates the solder paste in the hole. So if the contact is too long, this solder would no longer be able to reflow back into the plated through hole by capillary action during the soldering process, therefore the quality of the soldered connection would suffer as a result.

## Quantity of solder paste

Before the components are assembled, solder paste must be applied to all the solder pads (for connecting surface-mount components) and the plated through holes. To ensure that the plated through holes are completely filled, significantly more solder paste must be applied than traditional solder pads on the pcb surface. There are numerous calculation methods available which are complicated to apply. The following rule of thumb has proved valuable in practice:

$$VPaste = 2(VH - VP)$$

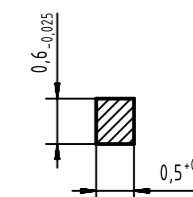
in which:

VPaste = Required volume of solder paste

VH = Volume of the plated through hole

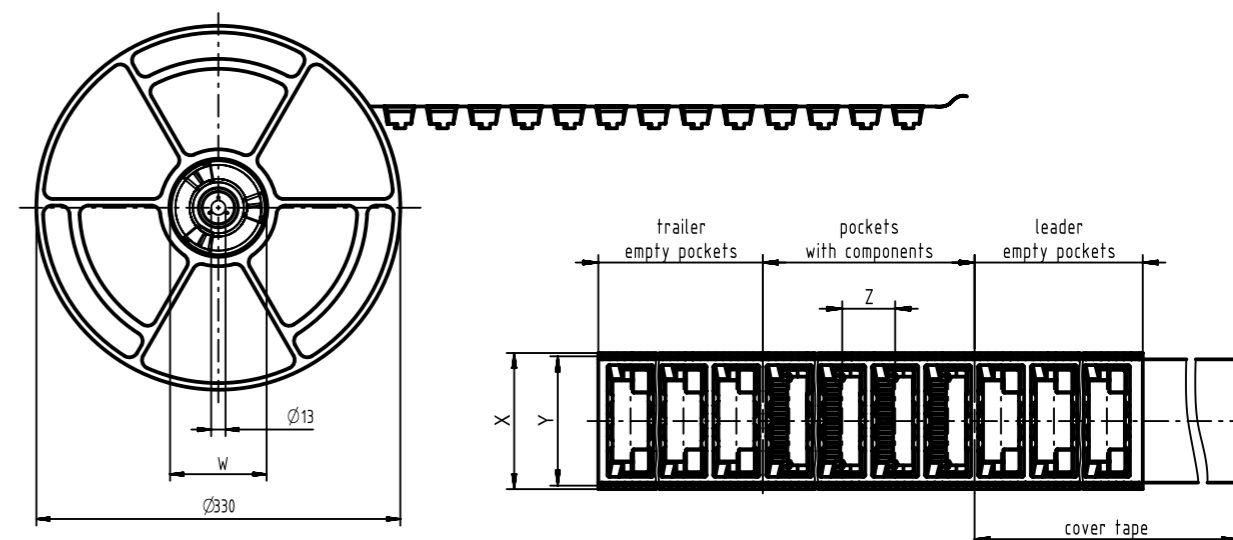
VP = Volume of the connector termination in the hole

Cross section of solder pins:  $A = 0,29mm^2 - 0,33mm^2$



Comment: the multiplier "2" compensates for solder paste shrinkage during soldering. For this purpose, it was assumed that 50 % of the paste consists of the actual solder, the other 50 % being soldering aids.

## Tape & reel layout acc. to EIA-481-D



type	2C	3B	3Q	3R
W	Ø 178mm	Ø 178mm	Ø 100mm	Ø 100mm
X	72mm	56mm	56mm	56mm
Y	68,4mm	52,4mm	52,4mm	52,4mm
Z	28mm	24mm	24mm	24mm
leading pockets	5	7	7	7
trailing pockets	6	9	9	9
pockets with components	150	180	130	80
cover tape	400mm	428mm	428mm	428mm

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